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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/072,743	02/07/2002	Ronnie M. Harrison	3758.2US (97-0153.1)	4046
24247	7590 06/30/2005		EXAM	INER
TRASK BRITT			NGUYEN, DONGHAI D	
P.O. BOX 2550 SALT LAKE CITY, UT 84110		•	ART UNIT	PAPER NUMBER
	, 		3729	

DATE MAILED: 06/30/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
	10/072,743	HARRISON ET AL.			
Office Action Summary	Examiner	Art Unit			
	Donghai D. Nguyen	3729			
The MAILING DATE of this communication	appears on the cover sheet with	h the correspondence address -			
Period for Reply A SHORTENED STATUTORY PERIOD FOR RE THE MAILING DATE OF THIS COMMUNICATIO - Extensions of time may be available under the provisions of 37 CFF after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a - If NO period for reply is specified above, the maximum statutory per - Failure to reply within the set or extended period for reply will, by state Any reply received by the Office later than three months after the meanned patent term adjustment. See 37 CFR 1.704(b).	N. R 1.136(a). In no event, however, may a represent the statutory minimum of thirty minimum of the statutory minimum of	ply be timely filed (30) days will be considered timely. HS from the mailing date of this communication. NDONED (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed on 1	5 April 2005.				
2a) This action is FINAL . 2b) ⊠ 7	This action is FINAL . 2b)⊠ This action is non-final.				
,	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.				
Disposition of Claims					
 4) Claim(s) 1-8,10,11 and 16-18 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 5) Claim(s) is/are allowed. 6) Claim(s) 1-8,10,11 and 16-18 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement. 					
Application Papers					
9) The specification is objected to by the Exam 10) The drawing(s) filed on is/are: a) Applicant may not request that any objection to	accepted or b)⊡ objected to b				
Replacement drawing sheet(s) including the control of the oath or declaration is objected to by the					
Priority under 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of: 1. Certified copies of the priority docum 2. Certified copies of the priority docum 3. Copies of the certified copies of the papplication from the International But * See the attached detailed Office action for a	nents have been received. I ents have been received in Appriority documents have been reau (PCT Rule 17.2(a)).	oplication No received in this National Stage			
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SE Paper No(s)/Mail Date 4/15/05.	Paper No(s)	ummary (PTO-413))/Mail Date formal Patent Application (PTO-152)			

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DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after allowance or after an Office action under *Ex Parte Quayle*, 25 USPQ 74, 453 O.G. 213 (Comm'r Pat. 1935). Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, prosecution in this application has been reopened pursuant to 37 CFR 1.114. Applicant's submission filed on April 15, 2005 has been entered.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

- (b) The invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claims 16-18 are rejected under 35 U.S.C. 102(b) as being anticipated by US Patent 5,200,362 to Lin et al.

Regarding claim 16, Lin et al disclose a method of fabricating an integrated circuit package, the method comprising: providing a semiconductor die (15) having a plurality of conductive pads (inherent because the die must have the pads for interconnect to the circuit pattern); forming at least two conductors (13, see Fig. 8), each conductor of the at least two conductors having a first end (the inner end) and a second end (along the transfer film) and a generally arcuate-shaped portion between the first and second ends, at least a portion of each

generally arcuate-shaped portion exhibiting a constant radius, and forming the generally arcuate-shaped portion of at least one of the at least two conductors to include a plurality of segments including at least one straight segment and at least one generally arcuate segment; configuring and positioning the at least two conductors such that line spacing between the generally arcuate-shaped portion of each of the at least two conductors is constant from their respective first ends to their respective second ends (see Fig. 8); electrically coupling the first ends of each of the at least two conductors with at least one of the plurality of conductive pads (16); and encapsulating the semiconductor die and at least a portion of the at least two conductors with an insulating material (20).

Regarding claims 17-18, Fig. 8 of Lin et al exhibit the plurality of segments having at least three segments with at least one segment of the plurality of segments to exhibit a different length than at least one other segment of the plurality of segments.

Claim Rejections - 35 USC § 103

- 4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 5. Claims 1-8 and 10-11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lin et al in view of US Patent 4,807,018 to Cellai.

Regarding claim 1, Lin et al disclose a method of fabricating an integrated circuit package, the method comprising: providing a semiconductor die (15) having a plurality of

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conductive pads (inherent because the die must have the pads for interconnect to the circuit pattern); forming at least two conductors (13 see Fig. 8), each conductor of the at least two conductors having a first end (inner ends) and a second end (along the side of element 12) and a generally arcuate-shaped portion between the first and second ends, at least a portion of each generally arcuate-shaped portion exhibiting a constant radius; configuring and positioning the at least two conductors such that line spacing between each of the at least two conductors is constant from their respective first ends to their respective second ends (see Fig. 8); electrically coupling the first ends of each of the at least two conductors with at least one of the plurality of conductive pads (16, See Fig. 2); and encapsulating the semiconductor die and at least a portion of the at least two conductors with an insulating material (20, see Fig. 3). However, Lin et al do not teach a leadframe including at least two conductors. Cellai teaches the lead frame (13) including at least two conductors (18) for providing good electrical contact and good mechanical and thermal connection (See Col. 1, lines 49-63). Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the invention of Lin et al by utilizing the teaching of leadframe having plurality of conductor as taught by Cellai in order to form an integrated circuit having good electrical contact and good mechanical and thermal connections.

The Fig. 8 meets all the limitations of claims 2-8, 10, and 11. Fig. 8 shows each of the two conductors (13) having three different segment, different arc length including constant radius throughout the entire arc length and substantially 90 degrees arc with the first and second ends of at least two conductors to be positioned at orientations of substantially 90 degrees relative to each other.

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Conclusion

6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. The prior art references cited for the teaching of fabricating an integrated circuit package.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Donghai D. Nguyen whose telephone number is (571)-272-4566. The examiner can normally be reached on Monday-Friday (9:00-6:00).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Peter D. Vo can be reached on (571)-272-4690. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

DN June 24, 2005

> PETER VO JUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 3700